



厦 门 华 联 电 子 股 份 有 限 公 司

Xiamen Hualian Electronics Corp., Ltd.

产 品 规 格 书

SPECIFICATION

产品名称：光 MOS 固态继电器

DESCRIPTION: Photo MOSFET Solid State Relay

产品型号：HSSR-41A06-×

PART NO.: HSSR-41A06-×

拟制 Prepared	审核 Verified	批准 Approved

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1 概述 General

产品 HSSR-41A06-× 由砷化铝镓红外发光二极管作为输入级耦合到高电压输出光探测电路。光探测电路由高速光电二极管阵列和驱动电路构成，用以开启/关断两个独立的高压金属氧化物半导体场效应管 (MOSFET)。一个最小 5mA 的电流流经输入级红外发光二极管可确保继电器动作。当加在输入级红外发光二极管的正向压降为 0.8V 或更小值时，继电器可确保复位。产品见图 1。

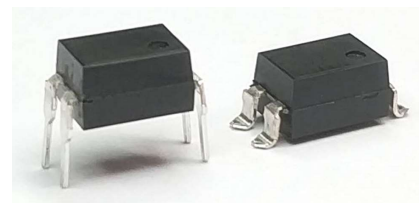


图 1 产品 Figure 1-Product

The HSSR-41A06-× consists of a AlGaAs infrared emitting diode input stage optically coupled to a high-voltage output detector circuit. The detector consists of a high-speed photovoltaic diode array and driver circuitry to switch on/off two discrete high voltage MOSFETs. The relay action with a minimum input current of 5mA through the input LED. The relay reset with an input voltage of 0.8V or less. Products shown in Figure 1.

2 特点 Features

- 单通道常开型单刀单掷继电器。Single Channel Normally on Single-Pole-Single-Throw (SPST) Relay.
- 60V 输出耐压产品。60V Output Withstand Voltage.
- 2000mA 额定电流产品。2000mA Current Rating.
- 低输入电流，CMOS 兼容。Low Input Current: CMOS Compatibility.
- 0.2 Ω 低通态电阻。0.2 Ω Low On-Resistance.
- 非常高的断开阻抗：典型值 10 兆欧。

Very High Output Off-state Impedance: 10 Teraohms Typical.

- 非常快的开关速度：典型值 2.5ms (Ton), 0.2ms (Toff)。

High Speed Switching: 2.5ms (Ton), 0.2ms (Toff) Typical

- 高输入输出绝缘耐压：5000 Vrms for 1 min。

High Input-to-Output Insulation Voltage: 5000 Vrms for 1 min.

3 应用 Applications

- 电信切换。Telecommunication Switching.
- 数据通讯。Data Communications.
- 电池管理。Battery management.
- 工业控制。Industrial Controls.
- 医疗设备。Medical equipment.
- EMR/机械继电器替代。EMR / Reed Relay Replacement.

4 电原理图 Schematic Diagram

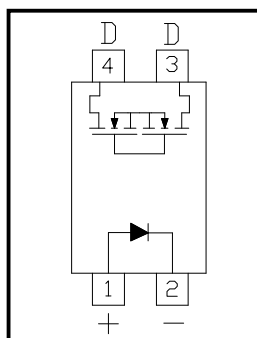


图 2 电原理图 Figure 2-Schematic

5 极限参数 Absolute Maximum Ratings

表 1 极限参数

Table 1-Absolute Maximum Ratings

参数名称 Characteristic		符号 Symbol	额定值 Rating	单位 Unit
输入端 Input	正向电流 Forward Current	I_F	50	mA
	反向电压 Reverse Voltage	V_R	5	V
	耗散功率（单个通道） Power Dissipation (Single channel)	P_M	75	mW
输出端 output	开关电压 Switching Voltage	$V_{O(MAX)}$	60	V
	连续通态电流 Continuous load current	$I_{O(MAX)}$	2000	mA
	耗散功率（单个通道） Power dissipation (Single channel)	P_C	360	mW
工作温度 Operating temp.		T_{aop}	-40 ~ +85	°C
贮存温度 Storage temp.		T_{stg}	-40 ~ +100	°C
焊接温度 Soldering Temperature	手工焊 Hand Soldering (5 Sec.)	T_{sld}	350	°C
	回流焊 Reflow Soldering (10 Sec.)		260	
	波峰焊 Wave Soldering (10 Sec.)		270	
绝缘电压 Isolation voltage (RH≤60%,交流 1 分钟) (RH≤60%, AC 1min.)		V_{ISO}	5000	V_{rms}

6 光电参数 Opto-Electrical Characteristics

表 2 光电参数

Table 2-Opto-Electrical Characteristics

$T_a=25^{\circ}\text{C}$

参数名称 Characteristic		符号 Symbol	测试条件 Test conditions	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
输入端 Input	正向电压 Forward voltage	V _F	I _F =10mA	-	1.2	1.3	V
	反向电流 Reverse current	I _R	V _R =5V	-	-	10	uA
	动作电流 Action Current	I _{F(ON)} ^a	I _O = 2000mA		2.5	5	mA
	复位电流 Reset Current	I _{F(OFF)}	I _O = 2000mA		0.5		mA
输出端 Output	断态漏电流 OFF-State Leakage Current	I _{OFF}	V _O = 60V			100	nA
	导通电阻 ON Resistance	R _{ON}	I _O =2000mA I _F =10mA		0.1	0.2	Ω
	输出电容 Output Capacitance	C _O	I _F =0mA, V _O =25V, f _O = 1MHz		16		pF

传输 Xfer	动作时间 Action Time	T_{ON}	$I_F=10mA, I_O=2000mA$		2.5	5.0	ms
	复位时间 Reset Time	T_{OFF}	$I_F=10mA, I_O=2000mA$		0.2	0.5	ms
	耦合电容 Coupled Capacitance	$C_{I/O}$			0.35		pF
隔离 Isolation	绝缘电压 Isolation voltage	V_{ISO}	$I_{off} \leq 0.3mA,$ AC, 60s	5000			V

^a 保证所有器件在 I_F 值小于或等于最大的 $I_{F(ON)}$ 时动作。
It is guaranteed that all devices active when I_F value is less than or equal to the maximum value of $I_{F(ON)}$.

7 外形尺寸及电原理图 Dimensions and Circuit Diagram

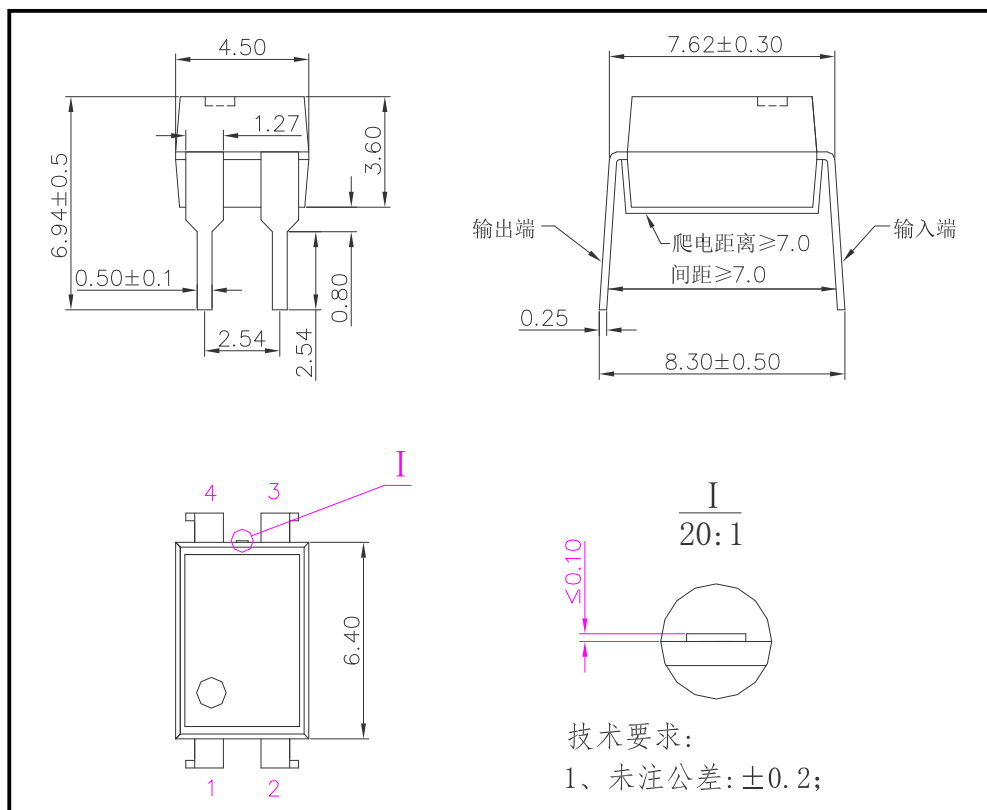


图 3 HSSR-41A06 外形尺寸
Figure 3- The dimensions of HSSR-41A06

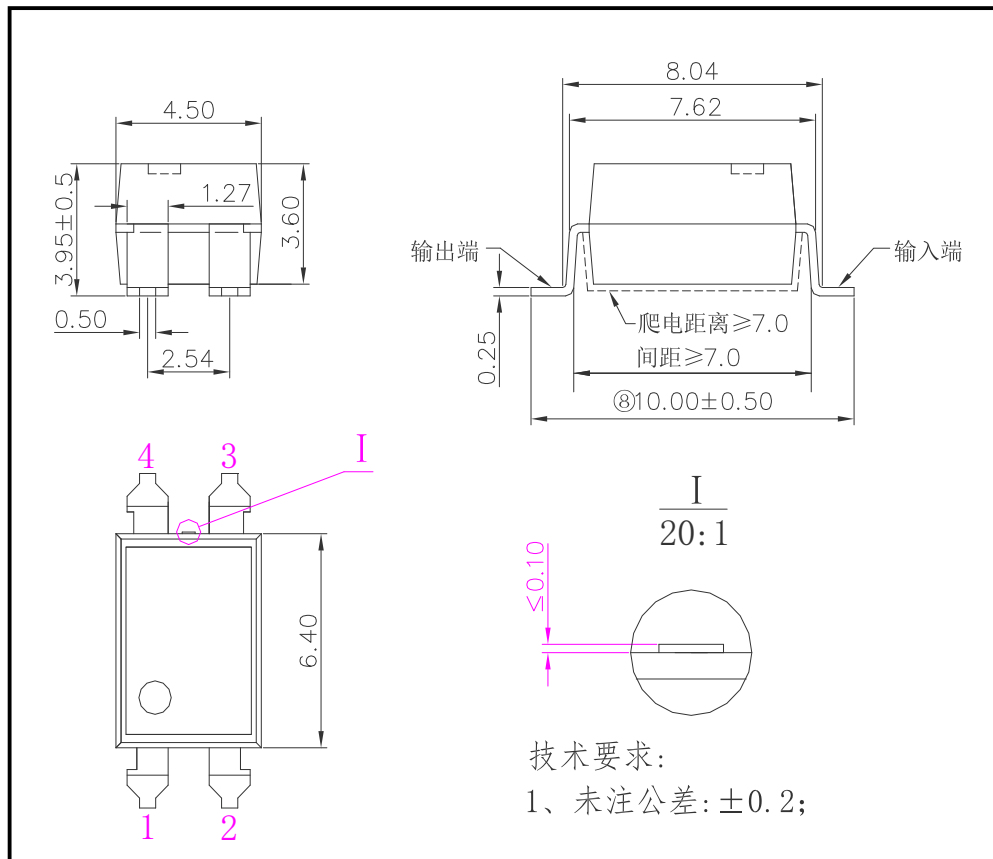


图 4 HSSR-41A06-2 外形尺寸

Figure 4- The dimensions of HSSR-41A06-2

8 标志 Mark

产品上应有型号、公司商标、生产日期代码、引出端识别标记。例如：HSSR-41A06-× 产品印章如图 5。

Print type characters ,trade mark and Lot.No.on the Photo Coupler.For example the marking of product HSSR-41A06-× is shown as figure 5.



图 5 产品印章

Figure 5- Marking

9 包装方式 Packing

9.1 条管包装 (Tube): 适用于 For HSSR-41A06。

9.1.1 每箱数量 (Qty/ctn): 40000 只 (pcs)。

9.1.2 内包装 (Inner packing):

每条管 100 只, 采用防静电条管, 条管上有商标、防静电标志。

100pcs/tube, antistatic tube, indication of trade mark and antistatic.

每纸匣 2000 只，贴合格证（型号、生产日期代号、检验员代号）。

2000pcs/bundle, certificate on one end (model, code of product date, Inspector's code) .

9.1.3 外包装(Outer packing):

公司名称、地址、商标、产品型号、数量等标志。

Indication of company name, address, trade mark, model and quantity.

9.1.4 示意图 (Schematic):

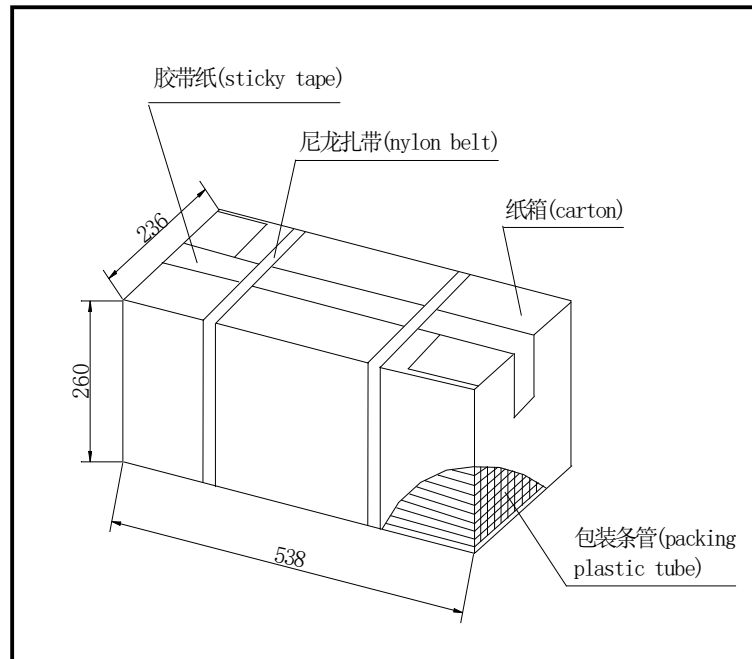


图 6 条管外包装

Figure 6- Outer packing for Tube

9.2 编带包装 (Tape and reel): 适用于 For HSSR-41A06-2。

9.2.1 每卷数量 (Qty/reel): 2000 只 (pcs)。每箱数量 (Qty/ctn): 20000 只 (pcs)。

9.2.2 内包装 (Inner packing):

每卷盘 2000 只，贴合格证（型号、生产日期代号、检验员代号）。

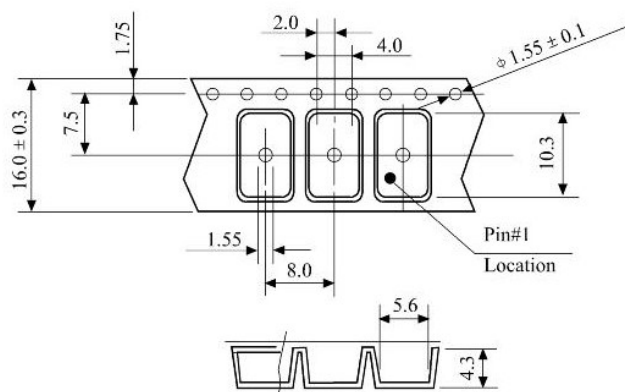
2000pcs/reel, certificate on reel (model, code of product date, Inspector's code)

9.2.3 外包装(Outer packing):

公司名称、地址、商标、产品型号、数量等标志。

Indication of company name, address, trade mark, model and quantity.

9.2.4 示意图 (Schematic):



卷盘外形图 Reel's Dimensions

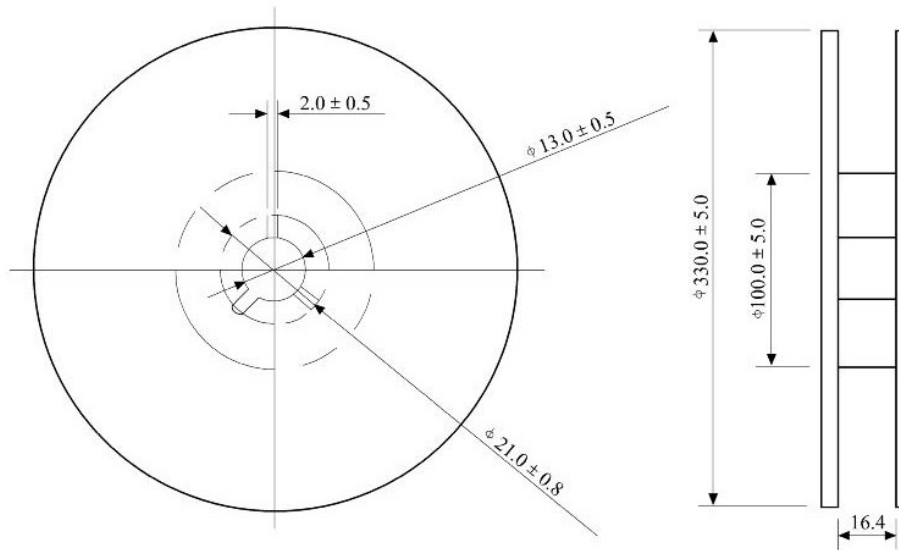


图 7 编带包装示意图
Figure 7- Taping Packing Schematic

9.3 标识 Label



图 8 标识 Figure 8-Label

9.4 注意事项 Note

9.4.1 推荐贮存温度 Recommend storage Temp.: 0~40°C;

推荐贮存湿度 Recommend storage humidity: <70%;

贮存有效期半年 Storage life: Half of a year.

9.4.2 湿气敏感度等级 3 级。MSL level: MSL 3.

9.5 引脚镀锡厚度: 大于等于 5μm, 平均 8μm~10μm。

Thickness of Sn which plated on lead frame: $\geq 5 \mu\text{m}$, average $8 \mu\text{m} \sim 10 \mu\text{m}$.

9.6 推荐焊接条件 Recommended Soldering Conditions

9.6.1 施加在环氧树脂上的温度不要超过最高贮存温度。

Not to apply high temperature exceeding the maximum storage temperature to the epoxy resin.

9.6.2 在高温下不要对环氧树脂施加压力。

Not to apply any force to the epoxy resin at high temperature.

9.6.3 焊接过程 Soldering process

1. 在焊接过程中不要对器件施加任何压力。

Not to apply any stress to the component during the soldering process.

2. 回流焊 Reflow soldering

- 1) 推荐锡膏规格 Recommend tin glue specifications:
 - a) 熔点 Melting temperature: 217°C
 - b) 组分 Contains: SnAg3Cu0.5
- 2) 回流焊工序必须在器件冷却至室温后进行。Never take next process until the component is cooled down to room temperature after reflow.
- 3) 推荐回流焊接参数，如下图所示： The recommended reflow soldering profile is following:

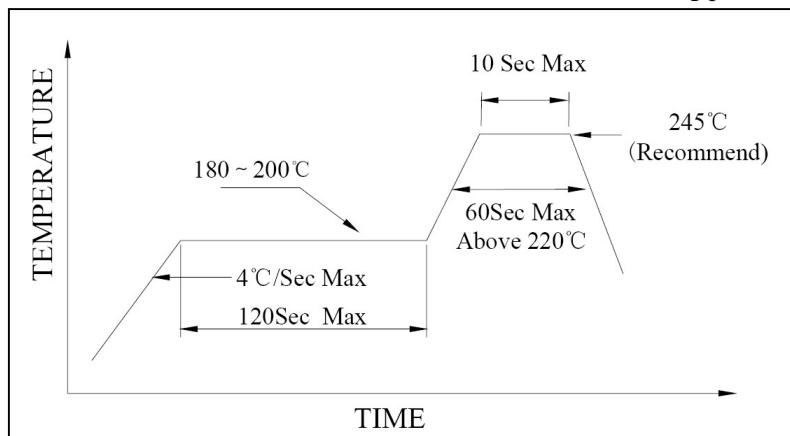


图 10 回流焊参数

Figure 10-Recommended reflow soldering profile

10 产地 Production Place

10.1 产地 Production Place: 中国厦门 Xiamen China;

10.2 工厂名称 Production NO.: 厦门华联电子股份有限公司; Xiamen Hualian Electronics Corp. , Ltd.;

10.3 工厂地址 Production Add.: 中国厦门市思明区前埔路 502 号 No.502, Qianpu Road, Siming District, Xiamen China.

